TSMC 06/07: 3.3V GPIO FT



Libraries

Name	Process	Form Factor
RGO_TSMC06_18V33_6FF_20F_FT	6FF	Staggered Flip Chip
RGO_TSMC07_18V33_7FF_20C_FT	7FF	Staggered Flip Chip

Summary

The 3.3V GPIO FT library provides general purpose bidirectional I/O cells that are fault tolerant. These programmable, multi-voltage I/O's give the system designer the flexibility to design to a wide range of performance targets.

This library is offered at both 6nm and 7nm. It is available in a staggered flip chip implementation.

To design an operational I/O power domain with these cells, an additional library is required – 3.3V Support: Power. That library contains an input-only buffer, isolated analog I/O, and a full complement of power cells along with corner and spacer cells to assemble a functional pad ring by abutment. An included rail splitter allows multiple power domains to be isolated in the same pad ring while maintaining continuous VDD/VSS for robust ESD protection.

ESD Protection:

- JEDEC compliant
 - 2kV ESD Human Body Model (HBM)
 - 500 V ESD Charge Device Model (CDM)

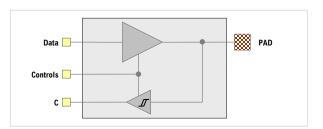
Latch-up Immunity:

- JEDEC compliant
 - Tested to I-Test criteria of ± 100mA @ 125°C

Cell Size & Form Factor

- Staggered (pad-limited) 34.08μm x 240.72μm
- Flip chip implementation with CUP structure built in

FRP_BI_SDS_33V_STB



Bidirectional GPIO Driver Features

- Fault tolerant no current flow when DVDD = 0V at $V_{PAD} \le 3.63V$
- Multi-Voltage (1.2V, 1.8V, 2.5V, 3.3V)
- LVCMOS / LVTTL input with selectable hysteresis
- Programmable drive strength (rated 2mA to 12mA)
- Selectable output slew rate
- Optimized for EMC with SSO factor of 8
- Open-drain output mode
- Programmable input options (hi-Z/pull-up/pull-down/repeater)
- Power-On Start (POS) capable
- Power sequencing independent design with Power-On Control

In full-drive mode, this driver can operate to frequencies in excess of 100MHz with 15pF external load and 125 MHz with 10pF load. Actual frequency limits are load and system dependent. A maximum of 200 MHz can be achieved under small capacitive loads.

Recommended operating conditions

	Description	Min	Nom	Max	Units
V_{VDD}	Core supply voltage	0.675	0.75	0.825	V
V _{DVDD}	I/O supply voltage	2.97	3.3	3.63	V
		2.25	2.5	2.75	V
		1.62	1.8	1.98	V
		1.08	1.2	1.32	V
T _J	Junction temperature	-40	25	125	°C
V_{PAD}	Voltage at PAD	V _{DVSS} -0.3	-	3.63	V

Characterization Corners

Model [1]	LPE Type	VDD=0.75V	DVDD [2]	Temp
FF	Cbest_CCbest	+10%	+10%	-40°C
FF	Cbest_CCbest	+10%	+10%	0°C
FF	Cbest_CCbest	+10%	+10%	125°C
FFG	Ctypical	+10%	+10%	125°C
TT	Ctypical	nominal	nominal	25°C
TT	Ctypical	nominal	nominal	85°C
SS	Cworst_CCworst	-10%	-10%	-40°C
SS	Cworst_CCworst	-10%	-10%	0°C
SS	Cworst_CCworst	: -10%	-10%	125°C

[1] Listed models are for 7FF. 6FF models are FFGNP / TT / SSGNP. [2] DVDD = 3.3V. 2.5V, 1.8V & 1.2V

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